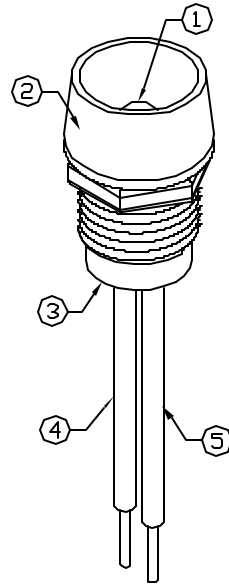
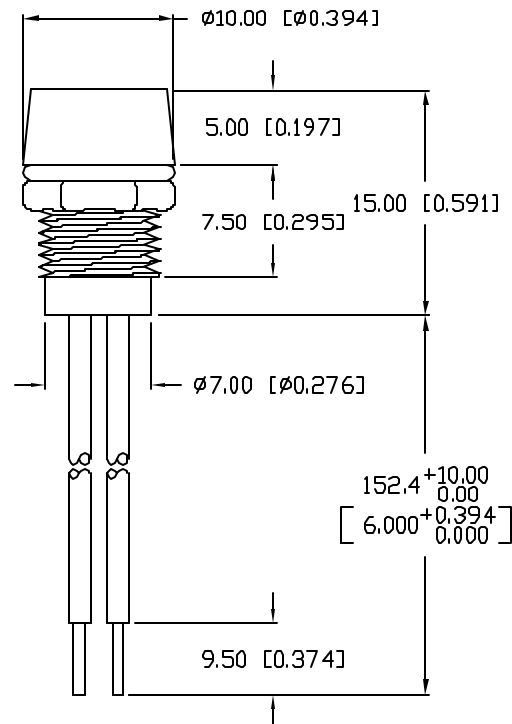
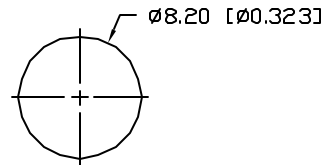


UNCONTROLLED DOCUMENT

PART NUMBER		REV.
SSI-LXR4815ID5V150		B
REV.	E.C.N. NUMBER AND REVISION COMMENTS	DATE
A	E.C.N. #10674.	10.30.00
B	E.C.N. #10BRDR. & REDRAWN IN 3D.	1.10.02



PANEL CUTOUT



NOTES:

1. SSL-LX5063ID-5V, RED LED. TRIM LEADS TO 5mm.
2. SSI-LXR4815, CHROME HOUSING.
3. SSH-LXH4815B5G, BLACK NYLON BUSHING. (NOT SEEN)
4. ANODE LEAD: LXP-WST24RDT0C, RED INSULATION, 160mm LONG, STRIP 2mm & 9.5mm.
5. CATHODE LEAD: LXP-WST24BLT0C, BLACK INSULATION, 160mm LONG, STRIP 2mm & 9.5mm.

ELECTRO-OPTICAL CHARACTERISTICS  $T_A=25^\circ\text{C}$   $V_f=5\text{V}$

PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		635		nm	
FORWARD VOLTAGE		5.0	7.0	$V_f$	
REVERSE VOLTAGE	5.0			$V_r$	$I_r=100\mu\text{A}$
AXIAL INTENSITY		20		mcd	$V_f=5\text{V}$
VIEWING ANGLE		60		2x theta	
EMITTED COLOR:	RED				
EPOXY LENS FINISH:	RED DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C

PARAMETER	MAX	UNITS
PEAK FORWARD VOLTAGE	7.0	V
STEADY CURRENT	12	mA
POWER DISSIPATION	310	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING, STORAGE TEMP.	-40 TO +85	°C

\*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), XX=±0.5 (±0.020), XXX=±0.25 (±0.010), XXXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN=  $^{+0.00}_{-0.00}$  DECIMAL PRECISION MAX=  $^{+0.00}_{-0.00}$  DECIMAL PRECISION

UNCONTROLLED DOCUMENT

REV.	PART NUMBER
B	SSI-LXR4815ID5V150

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T-5mm 635nm RED LED PANEL INDICATOR LED,  
 RED DIFFUSED LENS, WITH 6" WIRE LEADS, 5 VOLTS.

**RELIABILITY NOTE**  
 OUR MANY YEARS OF EXPERIENCE DATA ACCUMULATION INDICATE THAT SOLDER HEAT IS A MAJOR CAUSE OF EARLY AND FUTURE FAILURE. PLEASE PAY ATTENTION TO YOUR SOLDERING PROCESS.

DRAWN BY:	CHECKED BY:	APPROVED BY:	DATE: 12.19.95
BC			PAGE: 1 OF 1
			SCALE: N/A